

DEC 20 2006

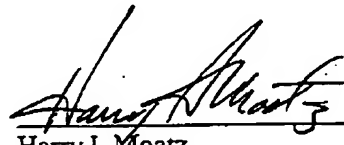
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Serial No:	Sunil Thomas	Docket No.:	TI-29525.1A
Art Unit:	10/695,026	Filed:	October 28, 2003
Customer No.:	2813	Examiner:	Jack S. J. Chen
Title:	23494	Conf. No.:	5704
	Flip-Chip Assembly of Protected Micromechanical Devices		

CERTIFICATION OF FACSIMILE TRANSMISSION

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12-20-06
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT <u>Sup. Amdt. 1.111 (6 Pages)</u>
<input type="checkbox"/> NEW APPLICATION	<input checked="" type="checkbox"/> EOT <u>2 month (1 Pages)</u>
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL (# Pages)
<input type="checkbox"/> ASSIGNMENT (# Pages)	<input type="checkbox"/> APPEAL (# Pages)
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE (# Pages)
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<input type="checkbox"/> CONTINUATION APPN (# Pages)	
<input type="checkbox"/> DIVISIONAL APPN	
NAME OF INVENTOR(S): Sunil Thomas	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/695,026	
TITLE OF INVENTION: Flip-Chip Assembly of Protected Micromechanical Devices	
TI FILE NO.: TI-29525.1A	DEPOSIT ACCT. NO.: 20-0668
FAXED: 12/20/2006	
DUE: 10/21/2006	
ATTY/SECY: TT/ms	

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